#### 3.2x1.6mm SMD CHIP LED LAMP



ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

KP-3216PBC

**BLUE** 

#### **Features**

- •3.2mmx1.6mm SMT LED, 1.1mm THICKNESS.
- •LOW POWER CONSUMPTION.
- •WIDE VIEWING ANGLE.
- •IDEAL FOR BACKLIGHT AND INDICATOR.
- •VARIOUS COLORS AND LENS TYPES AVAILABLE.
- •PACKAGE: 2000PCS/REEL.
- •RoHS COMPLIANT.

#### **Description**

The Blue source color devices are made with InGaN on SiC Light Emitting Diode.

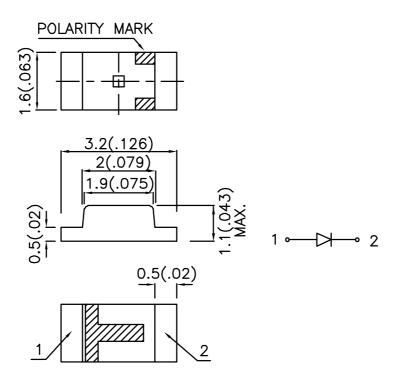
Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or

anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

#### **Package Dimensions**



#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.2 (0.0079)$  unless otherwise noted.
- 3. Specifications are subject to change without notice.

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#### **Selection Guide**

Part No.	Dice	Lens Type	lv (m @ 20	,	Viewing Angle
			Min.	Тур.	201/2
KP-3216PBC	BLUE (InGaN)	WATER CLEAR	18	60	120°

Note:

### Electrical / Optical Characteristics at Ta=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Blue	468		nm	IF=20mA
λD	Dominant Wavelength	Blue	470		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Blue	25		nm	IF=20mA
С	Capacitance	Blue	65		pF	VF=0V;f=1MHz
VF	Forward Voltage	Blue	3.65	4.2	V	IF=20mA
lR	Reverse Current	Blue		10	uA	VR = 5V

### Absolute Maximum Ratings at TA=25°C

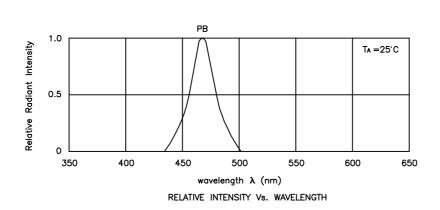
Parameter	Blue	Units		
Power dissipation	102	mW		
DC Forward Current	30	mA		
Peak Forward Current [1]	160	mA		
Reverse Voltage	5	V		
Operating / Storage Temperature	-40°C To +85°C			

Note

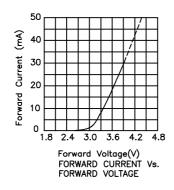
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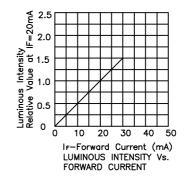
 $<sup>1.\,\</sup>theta 1/2$  is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

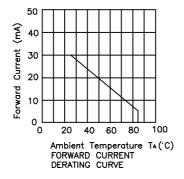
<sup>1. 1/10</sup> Duty Cycle, 0.1ms Pulse Width.

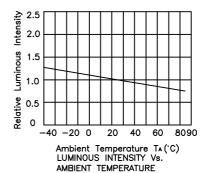


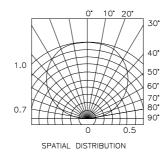
**Blue KP-3216PBC** 









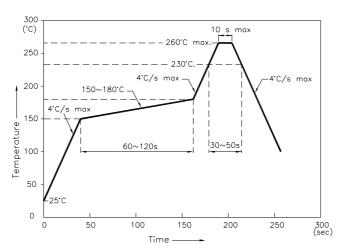


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### **KP-3216PBC**

Reflow Soldering Profile For Lead-free SMT Process.



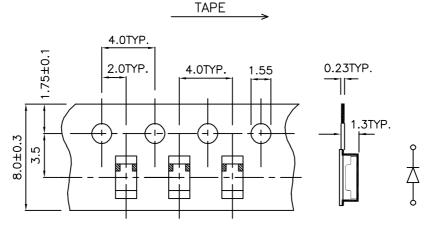
#### NOTES

- 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C.
- 2.Don't cause stress to the epoxy resin while it  $\,$  is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

### Recommended Soldering Pattern (Units: mm)



### Tape Specifications (Units: mm)



### Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

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